



# **SPECIFICATION**

(Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N : CL21B184KOANNNC

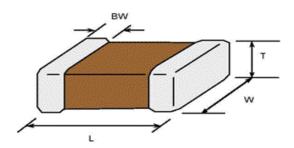
· Product : Multi-layer Ceramic Capacitor · Description : CAP, 180nF, 16V, ±10%, X7R, 0805

### A. Samsung Part Number

<u>CL</u> <u>21</u> <u>B</u> <u>184</u> <u>K</u> <u>O</u> <u>A</u> <u>N</u> <u>N</u> <u>N</u> <u>C</u> 1 2 3 4 5 6 7 8 9 0 10

| 1   | Series        | Samsung Multi-layer Ceramic Capacitor |         |                 |                         |                         |  |
|-----|---------------|---------------------------------------|---------|-----------------|-------------------------|-------------------------|--|
| 2   | Size          | 0805 (inch code)                      | L: 2.00 | ± 0.10 mm       | W: 1.25 ± 0.10 mr       | n                       |  |
| 3   | Dielectric    | X7R                                   | 8       | Inner electrode | Ni                      |                         |  |
| 4   | Capacitance   | 180 nF                                |         | Termination     | Cu                      |                         |  |
| (5) | Capacitance   | ±10 %                                 |         | Plating         | Sn 100%                 | (Pb Free)               |  |
|     | tolerance     |                                       | 9       | Product         | Normal                  |                         |  |
| 6   | Rated Voltage | 16 V                                  | 10      | Special         | Reserved for            | Reserved for future use |  |
| 7   | Thickness     | $0.65 \pm 0.10 \; \text{mm}$          | 11)     | Packaging       | Cardboard Type, 7" reel |                         |  |

#### **B. Structure & Dimension**



| Samsung P/N     | Dimension(mm) |             |             |                 |  |  |
|-----------------|---------------|-------------|-------------|-----------------|--|--|
| Samsung F/N     | L             | W           | Т           | BW              |  |  |
| CL21B184KOANNNC | 2.00 ± 0.10   | 1.25 ± 0.10 | 0.65 ± 0.10 | 0.50 + 0.2/-0.3 |  |  |

### C. Samsung Reliablility Test and Judgement Condition

|                                     | Judgement  | Test condition   |  |  |
|-------------------------------------|--|--|--|--|
| Capacitance                         | Within specified tolerance   | 1 <sup>kHz</sup> ±10% / 1.0±0.2Vrms  |  |  |
| <b>Γan δ (DF)</b> 0.035 max.        |  | *A capacitor prior to measuring the capacitance is heat treated at 150°C+0/-10°C for 1hour and maintained in ambient air for 24±2 hours. |  |  |
| Insulation 10,000Mohm or 100Mohm×µF |  | Rated Voltage 60~120 sec.  |  |  |
| Resistance                          | Whichever is smaller   |  |  |  |
| Appearance                          | No abnormal exterior appearance  | Microscope (×10)   |  |  |
| Withstanding                        | No dielectric breakdown or   | 250% of the rated voltage  |  |  |
| Voltage                             | mechanical breakdown   |  |  |  |
| Temperature                         | X7R  |  |  |  |
| Characteristics                     | (From-55°C to 125°C, Capacitance change                                | should be within ±15%)   |  |  |
| Adhesive Strength                   | No peeling shall be occur on the                                       | 500g·f, for 10±1 sec.  |  |  |
| of Termination                      | terminal electrode   |  |  |  |
| Bending Strength                    | Capacitance change : within ±12.5%                                     | Bending to the limit (1mm)   |  |  |
|                                     |  | with 1.0mm/sec.  |  |  |
| Solderability                       | More than 75% of terminal surface                                      | SnAg3.0Cu0.5 solder  |  |  |
|                                     | is to be soldered newly  | 245±5℃, 3±0.3sec.  |  |  |
|                                     |  | (preheating : 80~120°C for 10~30sec.)  |  |  |
| Resistance to                       | Capacitance change : within ±7.5%                                      | Solder pot : 270±5°C, 10±1sec.   |  |  |
| Soldering Heat                      | Tan δ, IR : initial spec.  |  |  |  |
| Vibration Test                      | Capacitance change : within $\pm$ 5% Tan $\delta$ , IR : initial spec. | Amplitude: 1.5mm From 10Hz to 55Hz (return: 1min.) 2hours × 3 direction (x, y, z)  |  |  |
| Moisture                            | Capacitance change: within ±12.5%                                      | With rated voltage   |  |  |
| Resistance                          | Tan δ: 0.05 max  | 40±2°C, 90~95%RH, 500+12/-0hrs   |  |  |
|                                     | IR : 500Mohm or 25Mohm × $\mu$ F<br>Whichever is smaller               |  |  |  |
| High Temperature                    | Capacitance change: within ±12.5%                                      | With 200% of the rated voltage   |  |  |
| Resistance                          | Tan δ : 0.05 max   | Max. operating temperature   |  |  |
|                                     | IR : 1,000Mohm or 50Mohm × $\mu$ F Whichever is smaller                | 1,000+48/-0hrs   |  |  |
| Temperature                         | Capacitance change: within ±7.5%                                       | 1 cycle condition  |  |  |
| Cycling                             | Tan δ, IR : initial spec.  | Min. operating temperature → 25°C  |  |  |
|                                     |  | → Max. operating temperature → 25°C  |  |  |
|                                     |  | 5 cycle test   |  |  |

<sup>\*\*</sup> The reliability test condition can be replaced by the corresponding accelerated test condition.

### D. Recommended Soldering method:

Reflow ( Reflow Peak Temperature : 260±5°C, 30sec. )



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

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- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- Military equipment
- 5 Disaster prevention/crime prevention equipment
- Any other applications with the same as or similar complexity or reliability to the applications set forth above.